

Pulin Global

SPECIFICATIONS

产品规格书

Customer		Name	5053 RGBW (2W)
		P/N	LEDRGBW5053-xxK-02

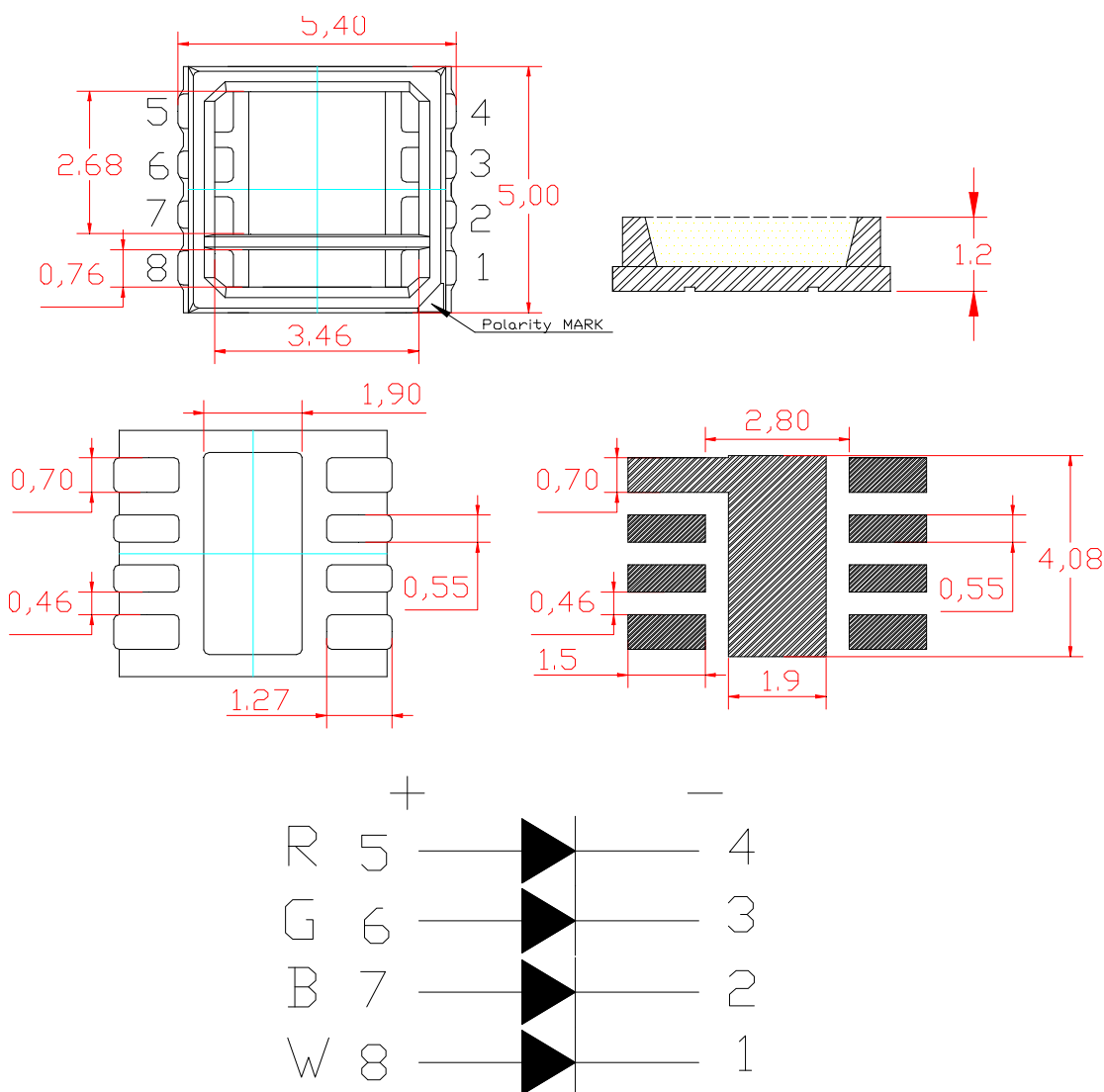


Website: <http://www.pulinglobal.com>

◆ Mechanical Specification (产品特性)

- **5.00mm*5.00mm*1.2mm SMD LED**
(表面贴片器件尺寸为5.00mm*5.00mm*.1.2mm)
- **The materials of the LED dice is InGaN**
(发光二极管所用芯片材料为氮化镓)
- **Suitable for all SMT assembly and welding process**
(适用于的所有的SMT装配和焊接工艺)
- **moisture resistant grade: Level 5a**
(防潮等级Level 5a)

◆ Package Outline (封装尺寸)



NOTES:

1. All dimensions are in millimeters (所有标注尺寸的单位均为毫米)
2. Tolerances are $\pm 0.2\text{mm}$ unless otherwise noted (除了特别注明, 所有标注尺寸的公差均为 $\pm 0.2\text{mm}$)
3. The bottom radiating pad is the positive pole with red light (底部散热焊盘为红光的正极)

◆ **Absolute maximum ratings at Ta=25℃（绝对最大额定值）**

Parameters（参数）	Symbol（符号）	Value（值）	Unit（单位）
Power Dissipation（功耗）	Pd	2000	mW
Forward Current（正向电流）	IF	150	mA
Pulse Forward Current（脉冲电流）	IFP	200	mA
Reverse Voltage（反向电压）	VR	5	V
Electrostatic Discharge（静电）	ESD	2000(HBM)	V
Operating Temperature（操作温度）	Topr	-40 ~ +85 ℃	℃
Storage Temperature（保存温度）	Tstg	-40 ~ +100 ℃	℃

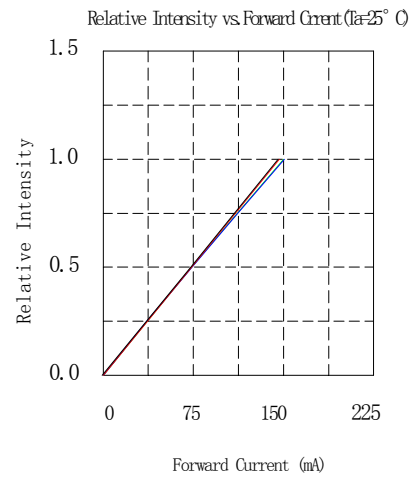
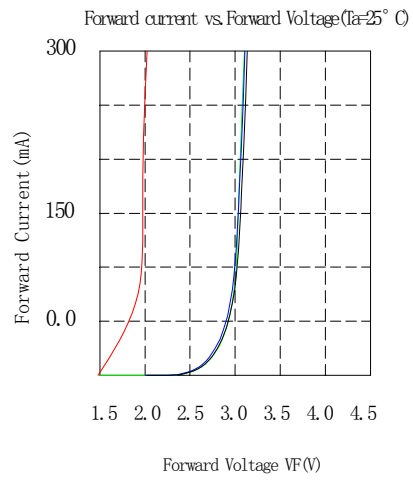
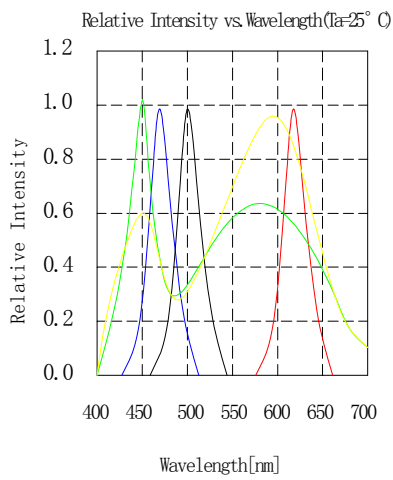
◆ **Electro-optical characteristics at Ta=25℃（电光特性）**

Item（项目）	Symbol（符号）		Mix（最小）	Typ（平均）	Max（最大）	Unit（单位）	Conditions（测试条件）
Forward voltage（正向电压）	VF	R	2.0		2.4	V	IF=150mA
		G	2.8		3.2		IF=150mA
		B	2.8		3.2		IF=150mA
		W	2.8		3.2		IF=150mA
Reverse current（反向电流）	IR		--	--	5	μA	VR = 5V
Dominant wavelength（主波长）	λd	R	620		625	nm	IF=150mA
		G	520		525		IF=150mA
		B	455		460		IF=150mA
Chromaticity（色温）	TC	W2	2600		2800	K	IF=150mA
		W3	2800		3200		IF=150mA
		W4	3800	--	4200		IF=150mA
		W6	6000	--	6500		IF=150mA
Color Rendering（显色指数）	Ra	--	80	--	85		IF=150mA
Luminous intensity（发光强度）	IV	R	15		20	lm	IF=150mA
		G	30		35		IF=150mA
		B	8		10		IF=150mA
	Φ	W	55	--	60	lm	IF=150mA

NOTE: (Tolerance: Iv ±10%, λd ±2nm, Vf ±0.05V)（公差：Iv ±10%, λd ±2nm, Vf ±0.05V）

◆ Typical optical characteristics curves (典型光学特性曲线)

Spectral Distribution



Derating

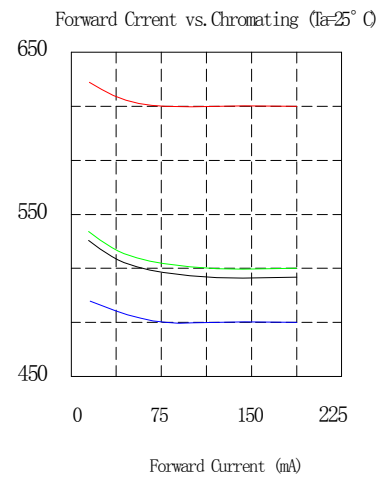
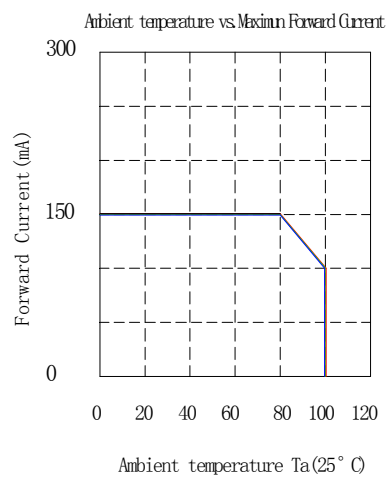
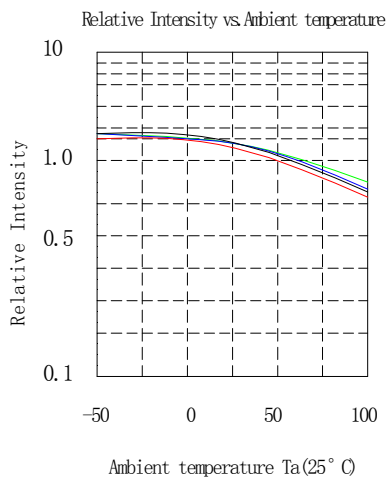
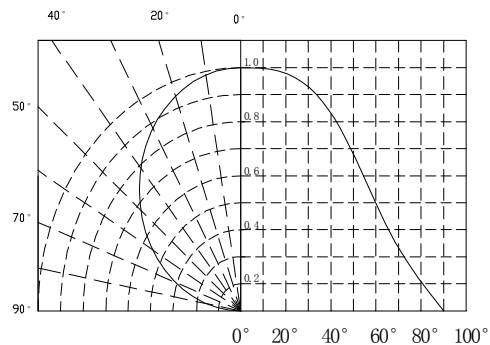
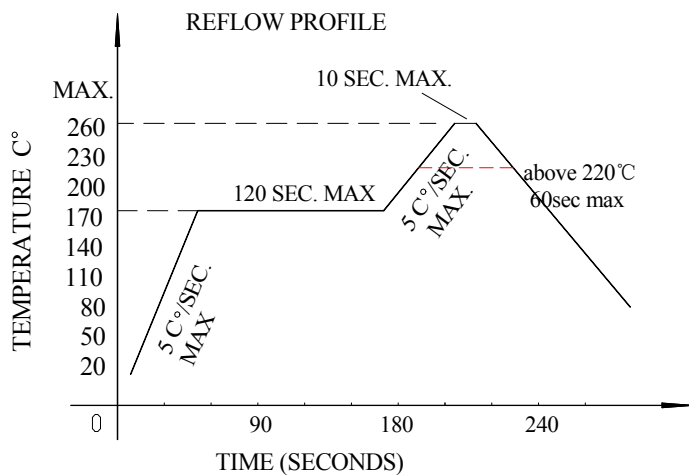


Diagram characteristics of radiation



◆ Reflow profile（焊接说明）

■ SMD Reflow Soldering Instructions（回流焊简介）



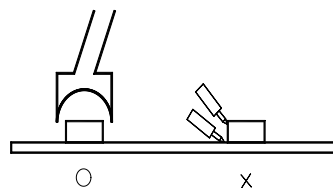
1. Reflow soldering should not be done more than two times
回流焊次数不应超过 2 次
2. When soldering, do not put stress on the LEDs during heating
焊接时，在加热过程中不能有应力作用于 LED 灯珠

■ Soldering iron（烙铁）

1. When hand soldering, keep the temperature of the iron under 300°C, and at that temperature keep the time under 3 sec.
手工焊接时，烙铁温度控制在 300°C 以下，且时间不可超过 3 秒
2. The hand soldering should be done only a time
手工焊接只可焊接一次

■ Rework（返工）

1. Customer must finish rework within 5 sec under 260°C
温度保持在 260°C 以下，5 秒内完成返工作业
2. The head of iron can not touch the LEDs
烙铁不能碰触到 LED 灯珠
3. Twin-head type is preferred.
双头形烙铁为最佳



■ CAUTIONS（注意事项）

The encapsulated material of the LEDs is silicone. Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will be influence to the reliability of the LEDs. Precautions should be taken to avoid the strong pressure on the encapsulated part. So when using the picking up nozzle, the pressure on the silicone resin should be proper.

封装的 LED 为硅材料。该 LED 具有软表面的封装顶部。顶部表面的压力会影响 LED 的可靠性。应采取预防措施，以避免有过大的压力作用于在封装件上。因此，在选用吸嘴时，应适用于有机硅树脂的压力。

◆ Product comparison table (产品对照表)

Product model (产品型号)	Lot number (产品批号)	Chromaticity (色温)	Luminous intensity (分光强)	Color Rendering (显色指数)
LEDRGBW5053-65K-02	GFW6**	6000-6500K	55-60LM	80
LEDRGBW5053-50K-02	GFW5**	4800-5200K	55-60LM	80
LEDRGBW5053-40K-02	GFW4**	3800-4200K	55-60LM	80
LEDRGBW5053-30K-02	GFW3**	2800-3200K	55-60LM	80
LEDRGBW5053-27K-02	GFW2**	2600-2800K	55-60LM	80

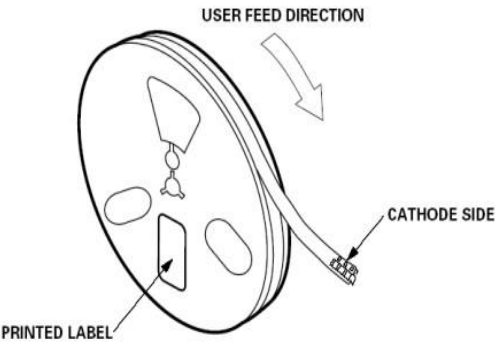
◆ Reliability (可靠性)

TEST ITEMS AND RESULTS (测试项目和结果)

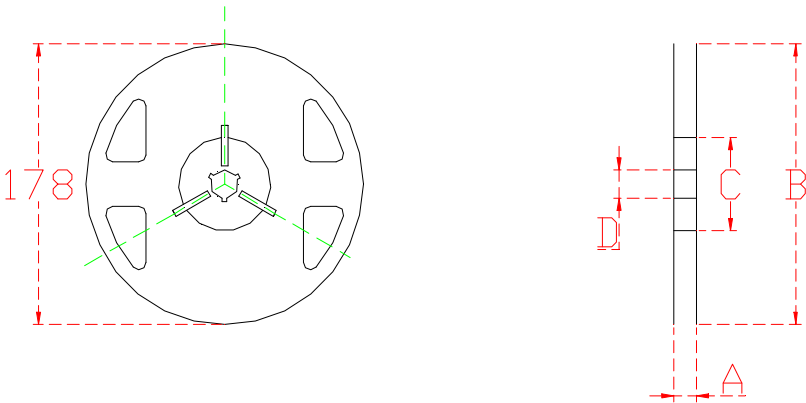
Test Items (测试项目)	Ref.Standard (参考标准)	Test Condition (测试条件)	Time (时间)	Quantity (数量)	Ac/Re (接收/拒收)
Reflow (回流焊)	JESD22-B106	Temp=260℃ max T=10sec	3 times	0/22	0/1
Temperature Cycle (温度 循环)	JESD22-A104	-20℃ ± 5℃ 30min ↑↓5min 120℃ ± 5℃ 30min	200 cycle	0/22	0/1
Thermal Shock (冷热冲击)	JESD22-A106	-40℃ ± 5℃ 15min ↑↓5sec 100℃ ± 5℃ 15min	200 cycle	0/22	0/1
High Temperature Storage (高温存储)	JESD22-A103	Temp=100℃ ± 5℃	1000 hrs	0/22	0/1
Low Temperature Storage (低温存储)	JESD22-A119	Temp=-40℃ ± 5℃	1000 hrs	0/22	0/1
Power temperature Cycling (点亮高低温循环)	JESD22-A105	On5min-40℃ > 5min ↑↓ ↑↓ < 5min Off5min 100℃ > 5min	200 cycle	0/22	0/1
Life Test (老化测试)	JESD22-A108	T _a =25℃ ± 5℃ I _F =150mA	1000 hrs	0/22	0/1
High Temperature High Humidity Life Test (高温高湿)	JESD22-A101	85℃ ± 5℃ / 85%RH I _F =150mA	1000 hrs	0/22	0/1

◆ Packaging Specifications (包装规格)

● Feeding Direction (进料方向)



● Dimensions of Reel (Unit: mm) (卷轴尺寸 (单位: 毫米))



A	8.0±0.1mm
B	178±1mm
C	60±1mm
D	13.0±0.5mm

1、Packing Icon（包装图标）

